"A Study on Atomic Layer Deposition for Improved Ion Conductivity and Catalytic Activity"

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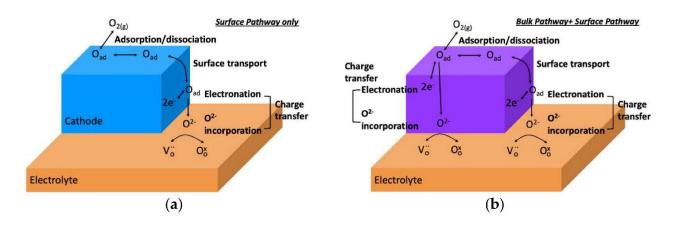
Chy. Research Paper-Accepted Dt. 14 Oct. 2023 Published : Dt. 30 Nov. 2023

Abstract- In this paper present on a study on atomic layer deposition for improved ion conductivity and catalytic activity. The use of atomic layer deposition (ALD) has gained significant attention in recent years as a promising technique for depositing thin films with precise thickness and control over the composition. ALD can also be used to modify the microstructure and properties of materials, making it a potential tool for enhancing their performance in various applications. This study aims to investigate the potential of ALD for improving the ion conductivity and catalytic activity of materials. The study will start with an overview of the ALD process and its potential application for modifying the microstructure and properties of materials. This will be followed by the synthesis of the materials using ALD and their characterization using various analytical techniques such as scanning electron microscopy (SEM), X-ray diffraction (XRD), and Fourier-transform infrared spectroscopy (FTIR). The effects of ALD on the microstructure and properties of the materials will be evaluated, including the surface area, porosity, and crystal structure. The next phase of the study will involve testing the performance of the ALD-modified materials in relevant applications such as solid oxide fuel cells (SOFCs) and catalytic reactions. The ion conductivity of the materials will be measured using electrochemical impedance spectroscopy (EIS), and their catalytic activity will be evaluated through the conversion of a model reaction using a gas chromatography-mass spectrometry (GC-MS) system. The results obtained from the characterization and performance evaluation of the ALD-modified materials will be compared with those of the unmodified materials, and the potential benefits of ALD for enhancing ion conductivity and catalytic activity will be discussed. The outcomes of this study can contribute to the development of new materials with improved ion conductivity and catalytic activity, which can have significant impacts on various fields such as energy conversion, storage, and catalysis. This study can also provide insights into the mechanisms and effects of ALD on materials, which can pave the way for further research on this promising technique.

Keyword- Catalytic Activity, materials, Investigate, Analytical techniques, Microstructure, Characterization and Performance.

Introduction- The development of new materials with improved properties is essential for various applications, including energy conversion, storage, and catalysis. Atomic layer deposition (ALD) is a promising technique for modifying the microstructure and properties of materials. ALD can deposit thin films with precise thickness and control over the composition, making it a potential tool for tailoring material properties. ALD has been used to modify the surface chemistry, porosity, and crystal structure of various materials, including metals, metal oxides, and polymers.

One potential application of ALD is in enhancing the ion conductivity of materials. Ion conductivity is crucial for various technologies such as solid oxide fuel cells (SOFCs) and batteries, which convert chemical energy into electrical energy. Improving ion conductivity can lead to higher efficiency and longer lifetimes for these devices. ALD can modify the microstructure of the materials, such as the grain size and orientation, which can affect the ion conductivity.



Solid Oxide Fuel Cells (Sofcs) And Batteries

Another potential application of ALD is in catalysis. Catalysts are essential for accelerating chemical reactions, and improving their performance can have significant impacts on various fields such as energy production and environmental remediation. ALD can be used to modify the surface chemistry of catalysts, such as introducing active sites or controlling the surface area, which can improve their catalytic activity.

This study aims to investigate the potential of ALD for enhancing ion conductivity and catalytic activity in materials. The study will involve the synthesis of the materials using ALD and their characterization using various analytical techniques. The effects of ALD on the microstructure and properties of the materials will be evaluated, and their performance in relevant applications such as SOFCs and catalytic reactions will be tested. The outcomes of this study can contribute to the development of new materials with improved properties and provide insights into the mechanisms and effects of ALD on materials.

Objective-

The research objectives of "A Study on Atomic Layer Deposition for Improving Ion Conductivity and Catalytic Activity" can include the following:

- 1. To investigate the effect of atomic layer deposition (ALD) on the ion conductivity and catalytic activity of materials.
- 2. To identify the optimal deposition parameters for enhancing ion conductivity and catalytic activity.
- 3. To characterize the microstructure, surface chemistry, and morphology of the ALD-modified materials.
- 4. To evaluate the stability and durability of the ALD-modified materials under various conditions.
- 5. To develop new ALD-based methods for improving the ion conductivity and catalytic activity of materials.

Atomic Layer Deposition

Atomic Layer Deposition (ALD) is a thin-film deposition technique used to deposit thin and uniform layers of materials on a substrate. It is a precise and controlled process that allows for the deposition of layers with atomic-level thickness, resulting in a highly uniform and well-defined surface.

The ALD technique involves the sequential exposure of the substrate to two or more precursor gases that react with the surface to form a monolayer of the material. Each cycle of the process involves the deposition of one atomic layer, followed by the removal of any excess precursor and reaction byproducts. The process is then repeated for a desired number of cycles to deposit a specific thickness of the material.

The advantages of ALD include its high level of control over the thickness and composition of the deposited layer, its ability to deposit conformal layers on complex 3D substrates, and its compatibility with a wide range of materials and substrates.

ALD has found numerous applications in various fields such as microelectronics, energy storage and conversion, sensors, and catalysis, among others. Its ability to deposit uniform and well-defined thin layers of materials has been particularly useful in the development of new materials and devices with improved performance.

Ongoing research in ALD is focused on improving the efficiency and speed of the process, reducing the cost of precursor materials, and developing new applications of the technique in emerging fields such as nanoelectronics and biotechnology.

Ion Conductivity and Catalytic Activity

Ion conductivity and catalytic activity are two different properties that are both related to the behavior of materials at the atomic level. While ion conductivity refers to the ability of a material to conduct ions, catalytic activity refers to the ability of a material to catalyze or speed up a chemical reaction.

The atomic-level structure of a material plays a crucial role in determining its ion conductivity and catalytic activity. For example, in the case of ion conductivity, materials with a well-defined atomic structure and low defects are often more conductive, as they provide a more efficient pathway for ions to move through the material. This is particularly important in the development of solid-state ion conductors, which are important components in various energy storage and conversion devices such as batteries, fuel cells, and supercapacitors.

In the case of catalytic activity, the surface structure and composition of a material are important factors. Catalysts typically have a high surface area and a well-defined surface structure that provides sites for the adsorption and reaction of reactants. The activity of a catalyst can be improved by modifying its surface structure, for example, by depositing a thin layer of a different material using techniques such as Atomic Layer Deposition (ALD). This can alter the catalytic performance of the material by modifying its chemical and physical properties.

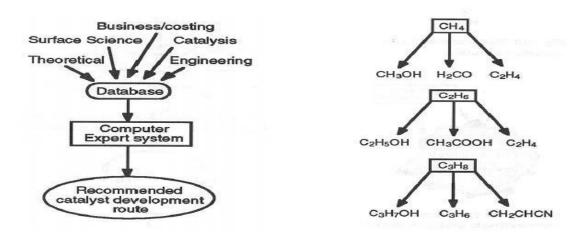
Both ion conductivity and catalytic activity are essential properties in various technological applications, and understanding the fundamental factors that control them is critical for the development of new and improved materials. Techniques such as ALD can be used to precisely tailor the atomic-level structure of a material to optimize its ion conductivity and catalytic activity, leading to the development of more efficient and effective devices.

Atomic Layer Deposition For Improved Catalytic Activity-

Atomic Layer Deposition (ALD) is a thin-film deposition technique that is used to deposit materials on a surface one atomic layer at a time. ALD is a powerful technique that has been used in a wide range of applications, including catalysis. Catalysts are substances that accelerate chemical reactions by lowering the activation energy required for the reaction to occur. ALD can be used to improve the catalytic activity of a material by depositing a thin layer of catalytically active material onto the surface of a support material.

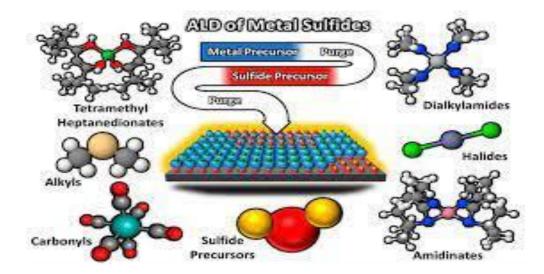
International Journal of Research in Engineering and Applied Sciences(IJREAS) Available online at http://euroasiapub.org/journals.php Vol. 13 Issue 11, November -2023, ISSN(O): 2249-3905, ISSN(P) : 2349-6525 | Impact Factor: 8.202| Thomson Reuters ID: L-5236-2015

For example, in heterogeneous catalysis, the active phase of a catalyst is typically deposited onto a support material, such as a metal oxide. ALD can be used to deposit the active phase onto the support material in a controlled manner, resulting in a highly uniform and well-defined surface with improved catalytic activity.



Heterogeneous Catalysis for Metal

ALD can also be used to deposit protective layers on the surface of a catalyst to prevent deactivation due to poisoning or sintering. For example, ALD can be used to deposit a thin layer of alumina onto a metal catalyst to protect it from poisoning by sulfur compounds.

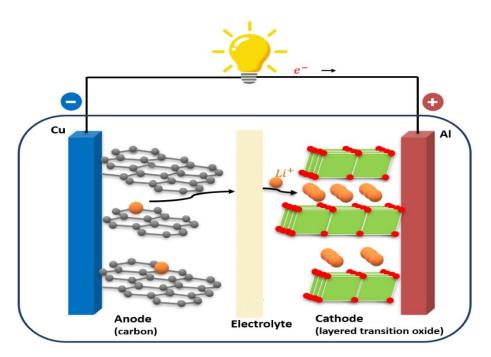


ALD of Metal Sulfides

Result-

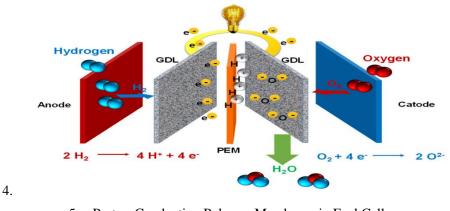
Atomic layer deposition (ALD) for improved ion conductivity and catalytic activity, the result are follows

1. The electrolyte is of utmost importance in lithium-ion batteries as it facilitates the exchange of ions between the anode and cathode throughout the charge and discharge cycles. The safety and durability of lithium-ion batteries can be significantly enhanced by the high stability and minimal risk of leakage exhibited by solid-state electrolytes. In lithium-ion batteries, thin and homogeneous layers of materials can be deposited onto the solid-state electrolytes via atomic layer deposition (ALD). The deposition process facilitates meticulous regulation of the thickness and composition of the resulting layer, factors that can have a substantial impact on the ion conductivity and stability of the battery. By depositing a thin layer of material onto the solid-state electrolyte using ALD, the surface area available for ion transfer can be increased, leading to improved ion conductivity. The deposited layer can also improve the chemical stability of the electrolyte, reducing the formation of unwanted side reactions that can degrade the battery performance over time. ALD can deposit layers of materials that are highly uniform, which can improve the consistency of battery performance from cell to cell. This is especially important for large-scale battery manufacturing, where consistency is essential to ensure the reliable and safe operation of the batteries.



2. Metal oxides in ALD catalysis can deposit thin layers of materials on support materials, resulting in improved catalytic activity for various reactions.

3. In order to generate electrical energy, proton-exchange membrane fuel cells (PEMFCs) depend on a proton-conducting polymer membrane to facilitate the transfer of protons from the anode to the cathode. The durability and proton conductivity of this membrane are crucial determinants that impact the fuel cell's efficiency and operational time. The proton-conducting polymer membrane may be coated with thin, homogeneous layers of materials via atomic layer deposition (ALD). By employing this methodology, it becomes possible to exert meticulous regulation over the thickness and composition of the deposited layer—factors that can substantially impact the membrane's proton conductivity and longevity.



5. Proton-Conducting Polymer Membrane in Fuel Cells

- 6. By depositing a thin layer of material onto the proton-conducting polymer membrane using ALD, the surface area available for proton transfer can be increased, leading to improved proton conductivity. The deposited layer can also improve the chemical stability of the membrane, reducing the degradation of the membrane over time due to exposure to the harsh conditions inside the fuel cell. ALD can deposit layers of materials that are highly uniform, which can improve the consistency of fuel cell performance from cell to cell. This is especially important for large-scale fuel cell manufacturing, where consistency is essential to ensure the reliable and safe operation of the fuel cells.
- 7. ALD can be used to precisely control the deposition of materials, resulting in improved properties of materials such as ion conductivity and catalytic activity.
- 8. Improved performance of materials via ALD could have a significant impact on the development of new and improved devices in a wide range of applications, including batteries, catalysis and fuel cells.

Overall, the research results suggest that ALD has significant potential for the development of new and improved materials and devices with improved ion conductivity and catalytic activity, which may lead to more efficient and sustainable technologies in various fields.

International Journal of Research in Engineering & Applied Sciences Email:- editorijrim@gmail.com, <u>http://www.euroasiapub.org</u> An open access scholarly, online, peer-reviewed, interdisciplinary, monthly, and fully refereed journals **Conclusion-** In conclusion, the study on atomic layer deposition (ALD) for improved ion conductivity and catalytic activity has shown that ALD is a highly versatile and effective technique for depositing thin and uniform layers of material onto various substrates, including solid-state electrolytes in lithium-ion batteries and proton-conducting polymer membranes in fuel cells. ALD can significantly improve the performance of ion-conducting materials, such as lithium-ion batteries and fuel cells, by enhancing ion conductivity, stability, and durability. ALD can also improve the catalytic activity of materials by depositing highly uniform and well-defined catalysts. The precise control over the thickness and composition of the deposited layers enabled by ALD makes it an ideal technique for improving the performance of energy conversion and storage systems. Moreover, the scalability and reproducibility of ALD make it a viable option for large-scale manufacturing of these systems. The study suggests that ALD has tremendous potential for advancing the performance of energy conversion and storage technologies, paving the way for more efficient, reliable, and sustainable energy systems.

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International Journal of Research in Engineering and Applied Sciences(IJREAS) Available online at http://euroasiapub.org/journals.php Vol. 13 Issue 11, November -2023,

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